#### SN54ABT16541, SN74ABT16541A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS SCBS118C – FEBRUARY 1991 – REVISED JANUARY 1997

SN54ABT16541 . . . WD PACKAGE **Members of the Texas Instruments** SN74ABT16541A . . . DGG, DGV, OR DL PACKAGE Widebus<sup>™</sup> Family (TOP VIEW) State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation 2 Latch-Up Performance Exceeds 500 mA Per **JEDEC Standard JESD-17** Typical V<sub>OLP</sub> (Output Ground Bounce) < 0.8 V at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C Distributed V<sub>CC</sub> and GND Pin Configuration Minimizes High-Speed Switching Noise • Flow-Through Architecture Optimizes PCB Layout High-Drive Outputs (-32-mA I<sub>OH</sub>, 64-mA I<sub>OI</sub>) Package Options Include Plastic 300-mil Shrink Small-Outline (DL), Thin Shrink Small-Outline (DGG), Thin Very Small-Outline (DGV) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Packages Using 25-mil Center-to-Center Spacings description The SN54ABT16541 and SN74ABT16541A are noninverting 16-bit buffers composed of two 8-bit

sections with separate output-enable signals. For either 8-bit buffer section, the two output-enable (10E1 and 10E2 or 20E1 and 20E2) inputs must both be low for the corresponding Y outputs to be active. If either output-enable input is high, the outputs of that 8-bit buffer section are in the high-impedance state.

		1 1		
10E1	1	$\cup$	48	10E2
1Y1 🛛	2		47	1A1
1Y2 🛛	3		46	1A2
gnd [	4		45	GND
1Y3 [	5		44	1A3
1Y4 🛛	6		43	1A4
v <sub>cc</sub> [	7		42	v <sub>cc</sub>
1Y5 🛛	8		41	1A5
1Y6 🛛	9		40	1A6
gnd [	10		39	GND
1Y7 🛛	11		38	1A7
1Y8 [	12		37	1A8
2Y1 🛛	13		36	2A1
2Y2 [	14		35	2A2
GND [	15		34	GND
2Y3 [	16		33	2A3
2Y4 [	17		32	2A4
v <sub>cc</sub> [	18		31	V <sub>CC</sub>
2Y5 [	19		30	2A5
2Y6 [	20		29	2A6
gnd [	21		28	GND
2Y7 🛛	22		27	2A7
2Y8 [	23		26	2A8
20E1	24		25	20E2

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16541 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16541A is characterized for operation from -40°C to 85°C.

(each 8-bit section)								
	INPUTS	OUTPUT						
OE1	OE2	Α	Y					
L	L	L	L					
L	L	Н	н					
н	Х	Х	Z					
X	Н	Х	Z					

## **FUNCTION TABLE**



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# SN54ABT16541, SN74ABT16541A 16-BIT BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

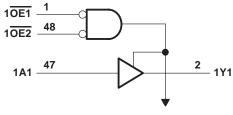
SCBS118C - FEBRUARY 1991 - REVISED JANUARY 1997

#### logic symbol<sup>†</sup>

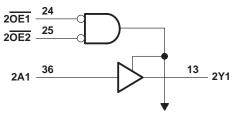
10E1	1	&			
10E2	48		EN1		
20E1	24	&			
20E1 20E2	25		EN2		
2022					
1A1	47		1 ⊽	2	1Y1
1A2	46	'		3	1Y2
1A2	44			5	1Y3
1A3	43			6	1Y4
	41			8	
1A5	40			9	1Y5
1A6 1A7	38			11	1Y6
	37			12	1Y7
1A8	36			13	1Y8
2A1	35	1	2 ▽	14	2Y1
2A2	33			16	2Y2
2A3	32			17	2Y3
2A4	30			19	2Y4
2A5	29			20	2Y5
2A6	27			22	2Y6
2A7	26			23	2Y7
2A8					2Y8

<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

#### logic diagram (positive logic)



**To Seven Other Channels** 



**To Seven Other Channels** 



## SN54ABT16541, SN74ABT16541A **16-BIT BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

$\begin{array}{llllllllllllllllllllllllllllllllllll$	V to 7 V to 5.5 V . 96 mA 128 mA -18 mA -50 mA 89°C/W 93°C/W
Storage temperature range, T <sub>stg</sub> 65°C t	

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

2. The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

#### recommended operating conditions (see Note 3)

			SN54AB	T16541	SN74ABT	16541A	UNIT
			MIN	MAX	MIN	MAX	UNIT
V <sub>CC</sub> Supply voltage				5.5	4.5	5.5	V
VIH High-level input voltage				EM	2		V
VIL	VIL Low-level input voltage					0.8	V
VI	VI Input voltage				0	VCC	V
ЮН	High-level output current		C)	-24		-32	mA
IOL	Low-level output current		202	48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled	4	10		10	ns/V
ТА	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: Unused inputs must be held high or low to prevent them from floating.



### SN54ABT16541, SN74ABT16541A **16-BIT BUFFERS/DRIVERS** WITH 3-STATE OUTPUTS

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#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		т	T <sub>A</sub> = 25°C			SN54ABT16541		SN74ABT16541A		
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX	UNIT		
VIK		V <sub>CC</sub> = 4.5 V,	lj = -18 mA			-1.2		-1.2		-1.2	V	
		$V_{CC} = 4.5 V,$	I <sub>OH</sub> = -3 mA	2.5			2.5		2.5		v	
Vari		$V_{CC} = 5 V,$	I <sub>OH</sub> = –3 mA	3			3		3			
VOH		V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = -24 mA	2			2				v	
		VCC = 4.5 V	I <sub>OH</sub> = -32 mA	2*					2			
VOL		V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA			0.55		0.55			V	
VOL		VCC = 4.5 V	I <sub>OL</sub> = 64 mA			0.55*				0.55	v	
V <sub>hys</sub>					100						mV	
Ц		V <sub>CC</sub> = 5.5 V,	$V_I = V_{CC} \text{ or } GND$			±1		<u>±</u> 1		±1	μA	
IOZH		V <sub>CC</sub> = 5.5 V,	$V_{O} = 2.7 V$			10		50		10	μA	
I <sub>OZL</sub>		V <sub>CC</sub> = 5.5 V,	$V_{O} = 0.5 V$			-10		-50		-10	μΑ	
loff		$V_{CC} = 0,$	VI or VO $\leq$ 4.5 V			±100	7			±100	μA	
ICEX		V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V	Outputs high			50	DUUC	50		50	μΑ	
10‡		V <sub>CC</sub> = 5.5 V,	V <sub>O</sub> = 2.5 V	-50	-100	-180	50	-180	-50	-180	mA	
		V <sub>CC</sub> = 5.5 V,	Outputs high			3		2		3	mA	
ICC		$I_{O} = 0,$	Outputs low			34		32		34		
		$V_I = V_{CC}$ or GND	Outputs disabled			3		2		3		
	Data	V <sub>CC</sub> = 5.5 V, One input at 3.4 V,	Outputs enabled			1		1.5		1		
∆ICC§	inputs	Other inputs at V <sub>CC</sub> or GND	Outputs disabled			0.05		0.05		0.05	mA	
Control V <sub>C</sub>		$V_{CC}$ = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND				1.5		1.5		1.5		
Ci	-	V <sub>I</sub> = 2.5 V or 0.5 V			3.5						pF	
Co		V <sub>O</sub> = 2.5 V or 0.5 V			3.5						pF	

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

<sup>†</sup> All typical values are at  $V_{CC} = 5 V$ .

<sup>‡</sup>Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

§ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.

#### switching characteristics over recommended ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER		FROM TO (INPUT) (OUTPUT)		V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C			SN54ABT16541		SN74ABT16541A	
		(001-01)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH		V	1	2.1	3	1	3.5	1	3.4	
<sup>t</sup> PHL	A	ř	1	2.5	3.6	1	4.3	1	4.2	ns
<sup>t</sup> PZH		Y	1.3	3.2	4.3	1.3	5.3	1.3	5.2	00
<sup>t</sup> PZL	OE		1.6	3.8	4.7	1.6	6.2	1.6	6	ns
<sup>t</sup> PHZ	OE	v	1.3	4.1	4.8	0.3	5.4	1.3	5.4	-
<sup>t</sup> PLZ	UE	T	1	3.3	4	Q 1	4.3	1	4.3	ns

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07V TEST **S**1 O Open **500** Ω **S**1 From Output tPLH/tPHL Open  $\Lambda \Lambda A$ **Under Test** 0 GND 7 V tPLZ/tPZL C<sub>L</sub> = 50 pF tPHZ/tPZH Open **500** Ω (see Note A) 3 V LOAD CIRCUIT **Timing Input** 1.5 V 0 V tw t<sub>su</sub> th 3 V 3 V 1.5 V 1.5 V Input **Data Input** 1.5 V 1.5 V 0 V 0 V **VOLTAGE WAVEFORMS VOLTAGE WAVEFORMS PULSE DURATION** SETUP AND HOLD TIMES 3 V 3 V Output 1.5 V 1.5 V 1.5 V 1.5 V Input Control 0 V 0 V <sup>t</sup>PZL Ð <sup>t</sup>PLH <sup>t</sup>PHL <sup>t</sup>PLZ Output VOH 3.5 V Waveform 1 1.5 V 1.5 V 1.5 V Output V<sub>OL</sub> + 0.3 V S1 at 7 V VOL VOL (see Note B) tPHZ -tPHL -<sup>t</sup>PLH <sup>t</sup>PZH Output VOH ۷он V<sub>OH</sub> – 0.3 V Waveform 2 1.5 V 1.5 V 1.5 V Output S1 at Open ≈ 0 V VOL (see Note B) **VOLTAGE WAVEFORMS** VOLTAGE WAVEFORMS **PROPAGATION DELAY TIMES** ENABLE AND DISABLE TIMES INVERTING AND NONINVERTING OUTPUTS LOW- AND HIGH-LEVEL ENABLING

#### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z<sub>Q</sub> = 50 Ω, t<sub>r</sub> ≤ 2.5 ns, t<sub>f</sub> ≤ 2.5 ns.
- C. All input pulses are supplied by generators having the following characteristics: PKR  $\leq$  10 MHz,  $2O = 50 \Omega$ ,  $t_{f} \leq 2.5 \text{ ns}$ ,  $t_{f} \leq 2.5 \text{ ns}$

D. The outputs are measured one at a time with one transition per measurement.

#### Figure 1. Load Circuit and Voltage Waveforms



TEXAS

#### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
74ABT16541ADGGRE4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ABT16541ADGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16541ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16541ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16541ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16541ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16541ADLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

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<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## **MECHANICAL DATA**

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

#### DGV (R-PDSO-G\*\*)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



## **MECHANICAL DATA**

MSSO001C - JANUARY 1995 - REVISED DECEMBER 2001

#### PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN

DL (R-PDSO-G\*\*)



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-118



## **MECHANICAL DATA**

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

#### DGG (R-PDSO-G\*\*)

#### PLASTIC SMALL-OUTLINE PACKAGE

**48 PINS SHOWN** 



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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